

IRHSNA57064

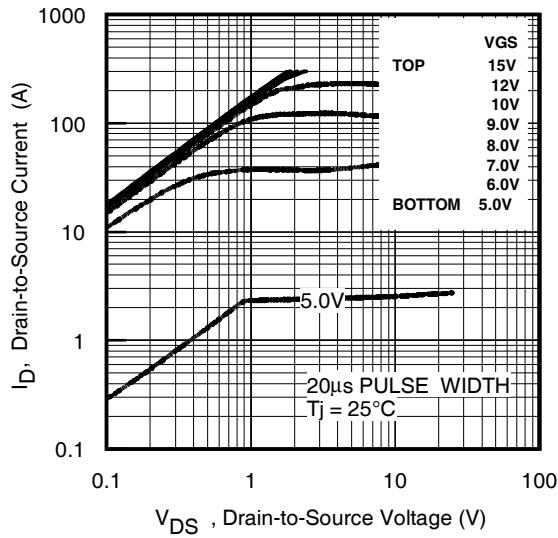


Fig 1. Typical Output Characteristics

Pre-Irradiation

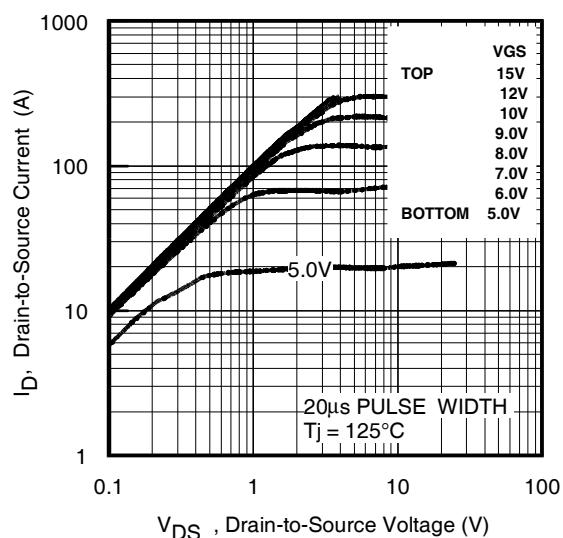


Fig 2. Typical Output Characteristics

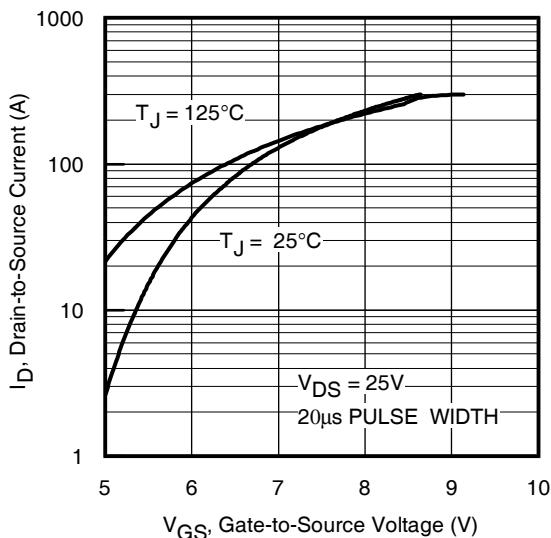


Fig 3. Typical Transfer Characteristics

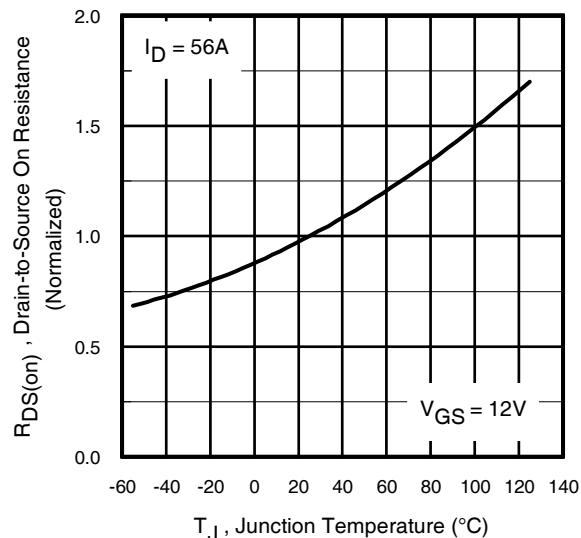


Fig 4. Normalized On-Resistance Vs. Temperature

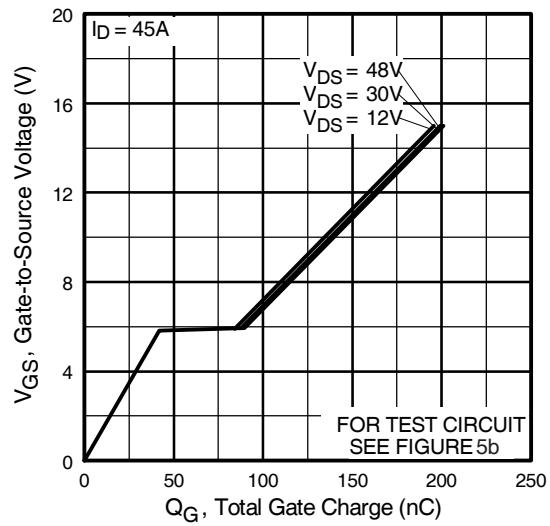


Fig 5. Typical Gate Charge Vs.
Gate-to-Source Voltage

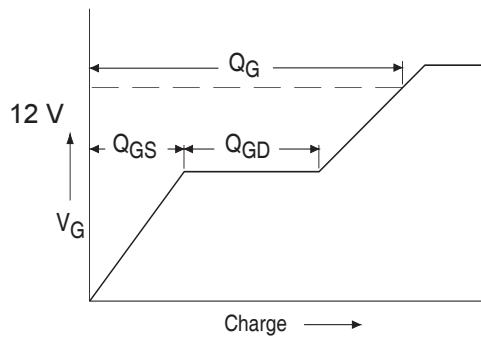


Fig 5a. Basic Gate Charge Waveform

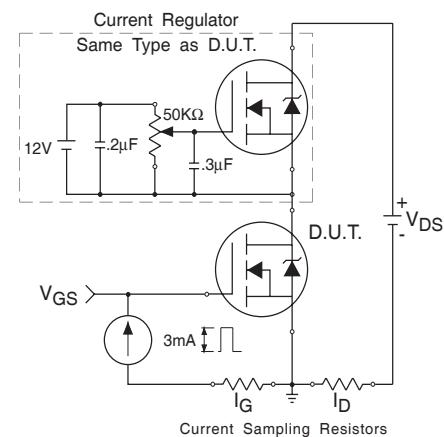


Fig 5b. Gate Charge Test Circuit

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Pre-Irradiation

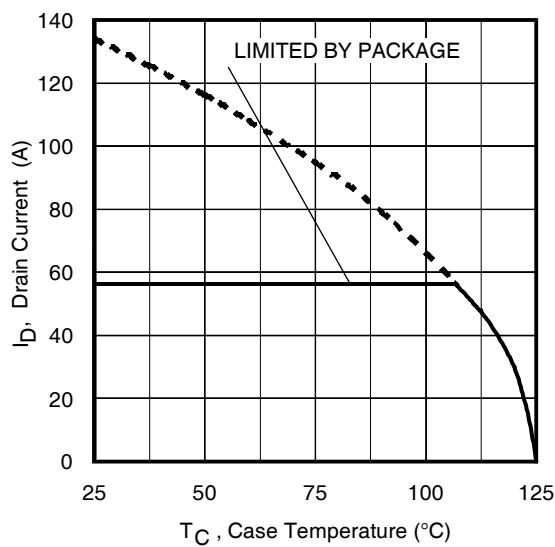


Fig 6. Maximum Drain Current Vs.
Case Temperature

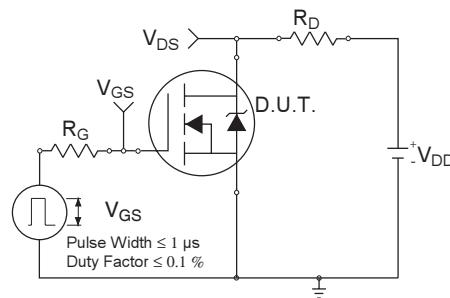


Fig 7a. Switching Time Test Circuit

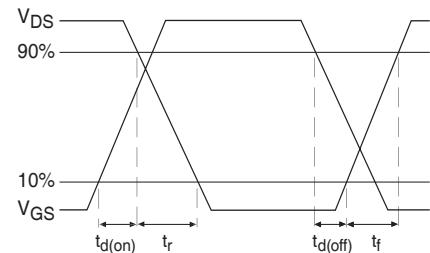


Fig 7b. Switching Time Waveforms

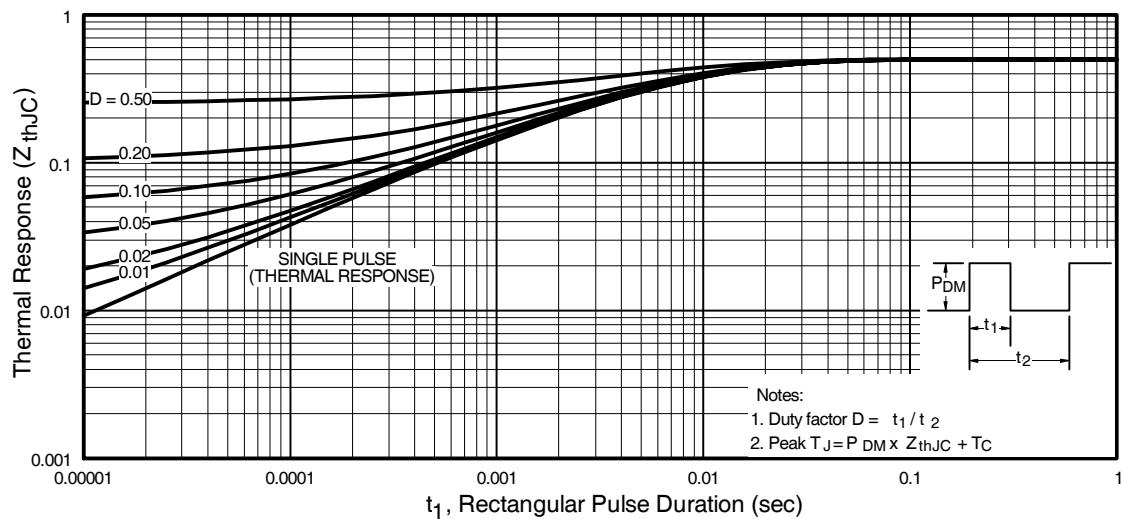


Fig 8. Maximum Effective Transient Thermal Impedance, Junction-to-Case, MOSFET

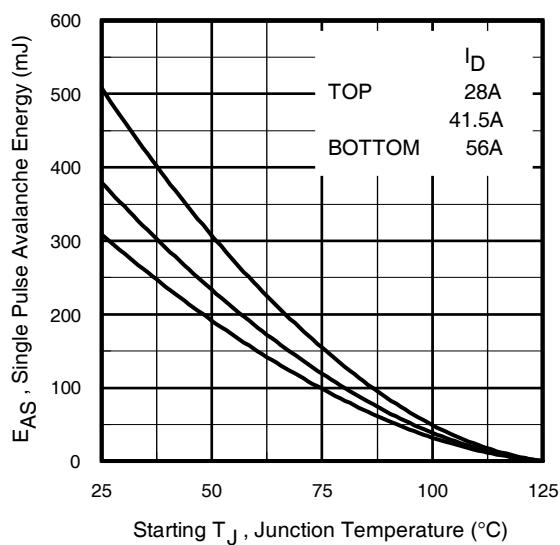


Fig 9. Maximum Avalanche Energy
Vs. Drain Current

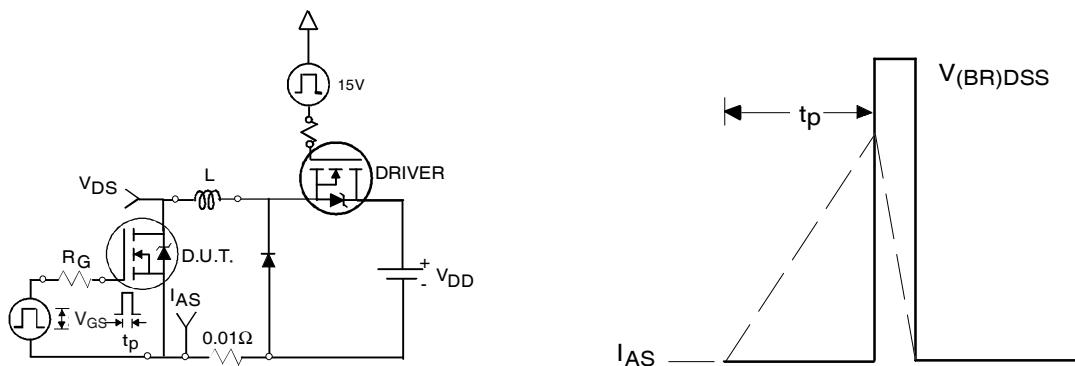


Fig 9a. Unclamped Inductive Test Circuit

Fig 9b. Unclamped Inductive Waveforms

MOSFET Body Diode & Schottky Diode Characteristics

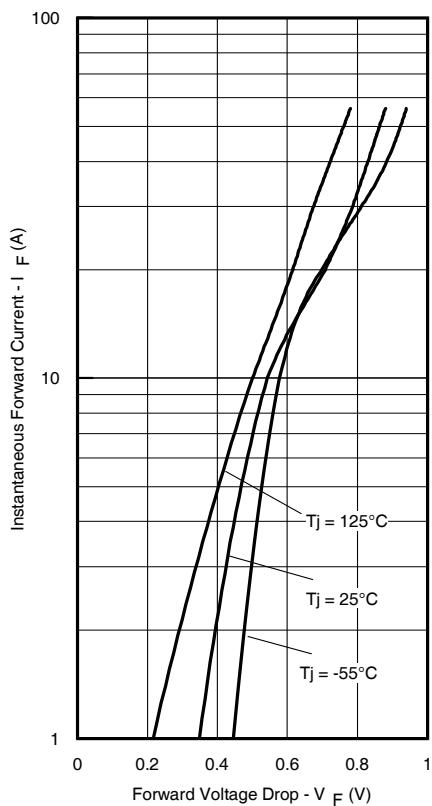


Fig. 10 - Typical Forward Voltage Drop Characteristics

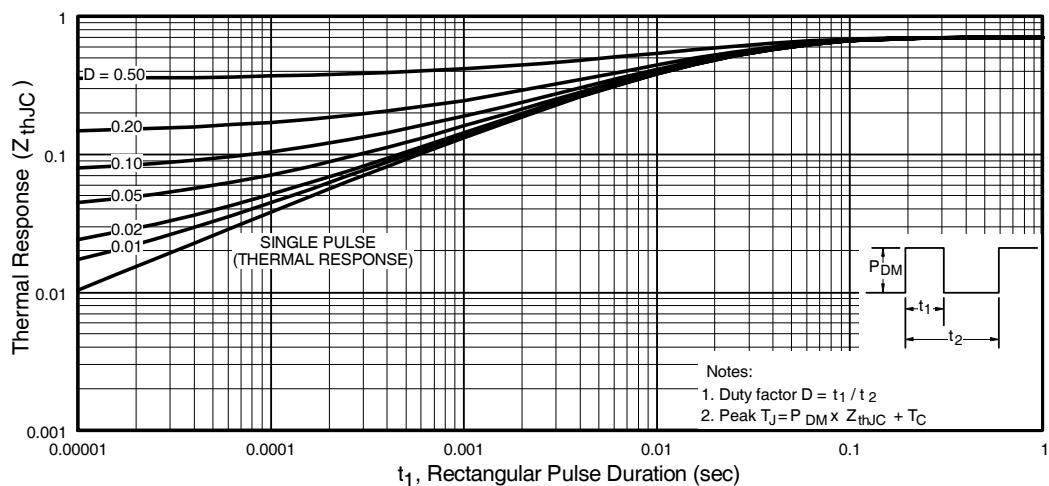
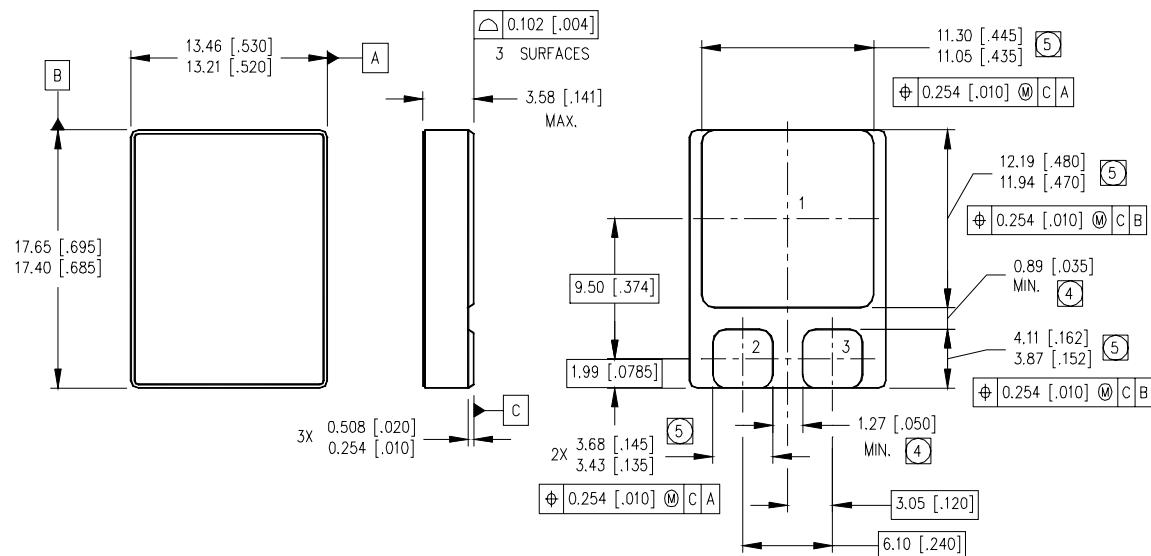


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case, Schottky

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature
- ② Pulse width $\leq 300 \mu\text{s}$; Duty Cycle $\leq 2\%$
- ③ 50% Duty Cycle, Rectangular
- ④ $V_{DD} = 25\text{V}$, starting $T_J = 25^\circ\text{C}$, $L = 0.2 \text{ mH}$
Peak $I_L = 56\text{A}$, $V_{GS} = 12\text{V}$
- ⑤ Total Dose Irradiation with V_{GS} Bias.
12 volt V_{GS} applied and $V_{DS} = 0$ during irradiation per MIL-STD-750, method 1019, condition A.
- ⑥ Total Dose Irradiation with V_{DS} Bias.
48 volt V_{DS} applied and $V_{GS} = 0$ during irradiation per MIL-STD-750, method 1019, condition A.
- ⑦ Specified Radiation Characteristics are for Radiation Hardened MOSFET die only.

Case Outline and Dimensions — SMD-2

NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- (4) DIMENSION INCLUDES METALLIZATION FLASH.
- (5) DIMENSION DOES NOT INCLUDE METALLIZATION FLASH.

PAD ASSIGNMENTS

- | | | |
|---|---|--------|
| 1 | = | DRAIN |
| 2 | = | GATE |
| 3 | = | SOURCE |

International
IR Rectifier
 AN INFINEON TECHNOLOGIES COMPANY

IR WORLD HEADQUARTERS: 101 N. Sepulveda Blvd., El Segundo, California 90245, USA Tel: (310) 252-7105

IR LEOMINSTER : 205 Crawford St., Leominster, Massachusetts 01453, USA Tel: (978) 534-5776

TAC Fax: (310) 252-7903

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Data and specifications subject to change without notice. 10/2015